

DATA SHEET

2SJ414 — General-Purpose Switching Device Applications

Features

- Low ON-state resistance.
- Low-voltage drive.
- Surface mount type device making the following possible.
 - · Reduction in the number of manufacturing processes for 2SJ414-applied equipment.
 - High density surface mount applications.
 - Small size of 2SJ414-applied equipment.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		-60	V
Gate-to-Source Voltage	VGSS		±20	V
Drain Current (DC)	ID		-18	A
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	-72	А
Allowable Power Dissipation	PD	Tc=25°C	40	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=-1mA, VGS=0V	-60			V
Gate-to-Source Breakdown Voltage	V(BR)GSS	IG=±100μA, VDS=0V	±20			V
Zero-Gate Voltage Drain Current	IDSS	VDS=-60V, VGS=0V			-100	μΑ
Gate-to-Source Leakage Current	IGSS	V _{GS} =±16V, V _{DS} =0V			±10	μΑ
Cutoff Voltage	V _{GS} (off)	V _{DS} =-10V, I _D =-1mA	-1.0		-2.0	V

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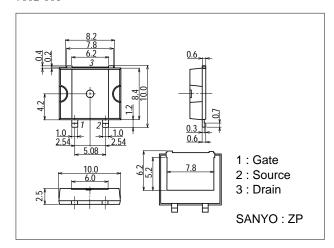
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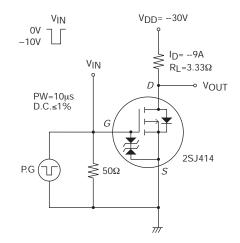
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Unit
Forward Transfer Admittance	yfs	V _{DS} =-10V, I _D =-9A	8.0	13.5		S
Static Drain-to-Source On-State Resistance	RDS(on)1	ID=-9A, VGS=-10V		60	80	mΩ
	RDS(on)2	ID=-9A, VGS=-4V		80	110	mΩ
Input Capacitance	Ciss	V _{DS} =-20V, f=1MHz		1900		pF
Output Capacitance	Coss	V _{DS} =-20V, f=1MHz		600		pF
Reverse Transfer Capacitance	Crss	V _{DS} =-20V, f=1MHz		150		pF
Turn-ON Delay Time	t _d (on)	See specified Test Circuit.		18		ns
Rise Time	tr	See specified Test Circuit.		35		ns
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		350		ns
Fall Time	tf	See specified Test Circuit.		250		ns
Diode Forward Voltage	VSD	IS=-18A, VGS=0V		-1.0	-1.5	V

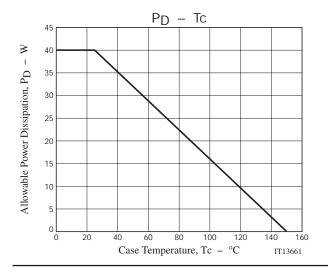
Package Dimensions

unit : mm (typ) 7002-001



Switching Time Test Circuit





Note on usage : Since the 2SJ414 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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